



Power MOSFETS

DATASHEET

LM40015NAL8A

N-Channel
Enhancement Mode MOSFET

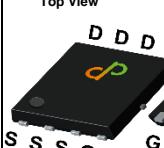
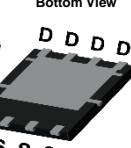
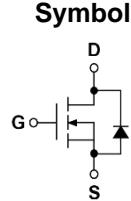
- Leadpower-semi CO., LTD.
- sales@leadpower-semi.com
- (03) 6577339 FAX : (03) 6577229
- www.leadpower-semi.com



Quality Management Systems
ISO 9001:2015 Certificate

N-Channel Enhancement Mode MOSFET

Pin Description

PDFN5*6	Symbol	Symbol	N-Channel	Unit
Top View 			V_{DSS}	40
			$R_{DS(ON)-Max}$	1.5
			I_D	208

Feature

- Fast switching speed
- Reliable and Rugged
- ROHS Compliant & Halogen-Free
- 100% UIS and Rg Tested

Applications

- Power Management in DC/DC Converters
- Server power supply
- Motor control
- Power OR-ing

Ordering Information

Orderable Part Number	Package Type	Form	Shipping	Marking
LM40015NAL8A	PDFN5*6	Tape & Reel	5000 / Tape & Reel	40015 □□□□□□

Note : □□□□□□ = Lot Code

Absolute Maximum Ratings ($T_J=25^\circ\text{C}$ Unless Otherwise Noted)

Symbol	Parameter	N-Channel	Unit
V_{DSS}	Drain-Source Voltage	40	V
V_{GSS}	Gate-Source Voltage	± 20	
T_J	Maximum Junction Temperature	150	$^\circ\text{C}$
T_{STG}	Storage Temperature Range	-55 to 150	$^\circ\text{C}$
I_S	Diode Continuous Forward Current	$T_c=25^\circ\text{C}$	A
$I_{DM}^{\text{(1)}}$	Pulse Drain Current Tested	$T_c=25^\circ\text{C}$	A
I_D	Continuous Drain Current	$T_c=25^\circ\text{C}$	A
		$T_c=100^\circ\text{C}$	
P_D	Maximum Power Dissipation	$T_c=25^\circ\text{C}$	W
		$T_c=100^\circ\text{C}$	
I_D	Continuous Drain Current	$T_A=25^\circ\text{C}$	A
		$T_A=70^\circ\text{C}$	
P_D	Maximum Power Dissipation	$T_A=25^\circ\text{C}$	W
		$T_A=70^\circ\text{C}$	
$I_{AS}^{\text{(2)}}$	Avalanche Current, Single pulse	L=0.1mH	A
		L=0.5mH	
$E_{AS}^{\text{(2)}}$	Avalanche Energy, Single pulse	L=0.1mH	mJ
		L=0.5mH	

Thermal Characteristics

Symbol	Parameter	Rating	Unit
$R_{\theta JC}$	Thermal Resistance-Junction to Case	Steady State	$^\circ\text{C}/\text{W}$
$R_{\theta JA}^{\text{(3)}}$	Thermal Resistance-Junction to Ambient	Steady State	$^\circ\text{C}/\text{W}$

Note ① : Max. current is limited by bonding limit

Note ② : UIS tested and pulse width are limited by maximum junction temperature 150°C

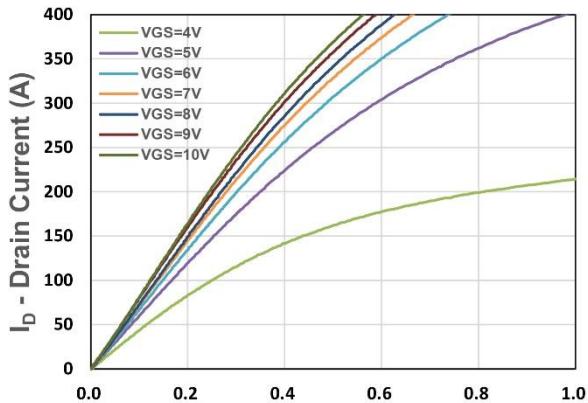
Note ③ : Surface Mounted on 1in² FR-4 board with 1oz

N-Channel Electrical Characteristics ($T_J=25^\circ\text{C}$ Unless Otherwise Noted)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
Static Electrical Characteristics						
$\mathbf{BV_{DSS}}$	Drain-Source Breakdown Voltage	$V_{GS}=0\text{V}$, $I_{DS}=250\mu\text{A}$	40	-	-	V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS}=32\text{V}$, $V_{GS}=0\text{V}$	-	-	1	μA
$V_{GS(\text{th})}$	Gate Threshold Voltage	$V_{DS}=V_{GS}$, $I_{DS}=250\mu\text{A}$	1.2	1.7	2.2	V
I_{GSS}	Gate Leakage Current	$V_{GS}=\pm 20\text{V}$, $V_{DS}=0\text{V}$	-	-	± 100	nA
$R_{DS(\text{ON})}^{\text{(4)}}$	Drain-Source On-state Resistance	$V_{GS}=10\text{V}$, $I_{DS}=20\text{A}$	-	1.1	1.5	$\text{m}\Omega$
		$V_{GS}=4.5\text{V}$, $I_{DS}=15\text{A}$		1.7	2.2	
g_{fs}	Forward Transconductance	$V_{DS}=5\text{V}$, $I_{DS}=10\text{A}$	-	36	-	S
Dynamic Characteristics ⁽⁵⁾						
R_G	Gate Resistance	$V_{GS}=0\text{V}$, $V_{DS}=0\text{V}$, Freq.=1MHz	-	3.4	-	Ω
C_{iss}	Input Capacitance	$V_{GS}=0\text{V}$, $V_{DS}=20\text{V}$, Freq.=1MHz	-	4523	-	pF
C_{oss}	Output Capacitance		-	1943	-	
C_{rss}	Reverse Transfer Capacitance		-	178	-	
$t_{d(\text{ON})}$	Turn-on Delay Time	$V_{GS}=10\text{V}$, $V_{DS}=20\text{V}$, $I_D=20\text{A}$, $R_{GEN}=2\Omega$	-	15.5	-	nS
t_r	Turn-on Rise Time		-	15.3	-	
$t_{d(\text{OFF})}$	Turn-off Delay Time		-	65.6	-	
t_f	Turn-off Fall Time		-	84.8	-	
Q_g	Total Gate Charge	$V_{GS}=4.5\text{V}$, $V_{DS}=20\text{V}$ $I_D=20\text{A}$	-	48.1	-	nC
Q_g	Total Gate Charge	$V_{GS}=10\text{V}$, $V_{DS}=20\text{V}$, $I_D=20\text{A}$	-	93	-	
Q_{gs}	Gate-Source Charge		-	17.6	-	
Q_{gd}	Gate-Drain Charge		-	20.9	-	
Source-Drain Characteristics						
$V_{SD}^{\text{(4)}}$	Diode Forward Voltage	$I_{SD}=10\text{A}$, $V_{GS}=0\text{V}$	-	0.7	1.1	V
t_{rr}	Reverse Recovery Time	$I_F=10\text{A}$, $V_R=20\text{V}$ $dI_F/dt=100\text{A}/\mu\text{s}$	-	64.5	-	nS
Q_{rr}	Reverse Recovery Charge		-	84.2	-	nC

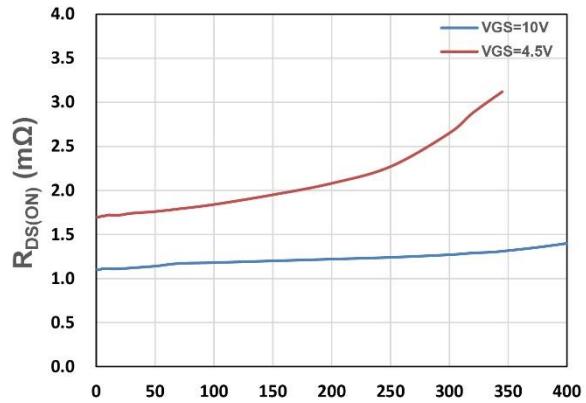
Note ⁽⁴⁾ : Pulse test (pulse width $\leq 300\mu\text{s}$, duty cycle $\leq 2\%$).Note ⁽⁵⁾ : Guaranteed by design, not subject to production testing.

N-Channel Typical Characteristics



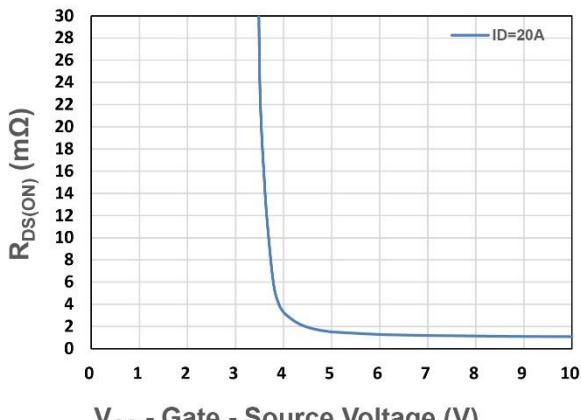
V_{DS} - Drain - Source Voltage (V)

Figure 1. Output Characteristics



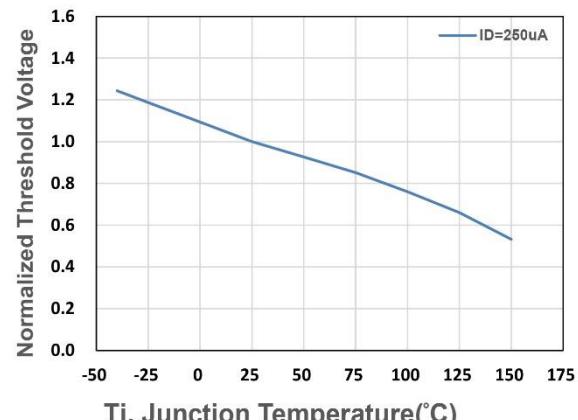
I_D - Drain Current (A)

Figure 2. On-Resistance vs. ID



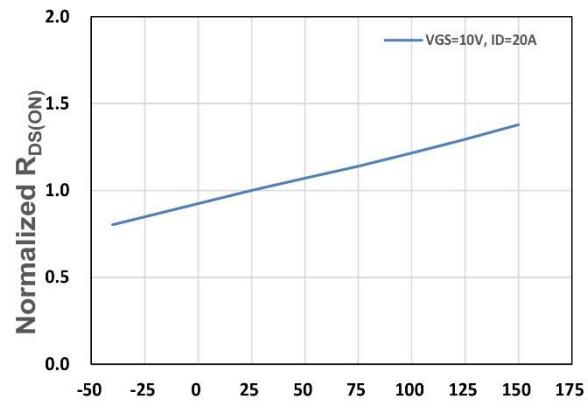
V_{GS} - Gate - Source Voltage (V)

Figure 3. On-Resistance vs. VGS



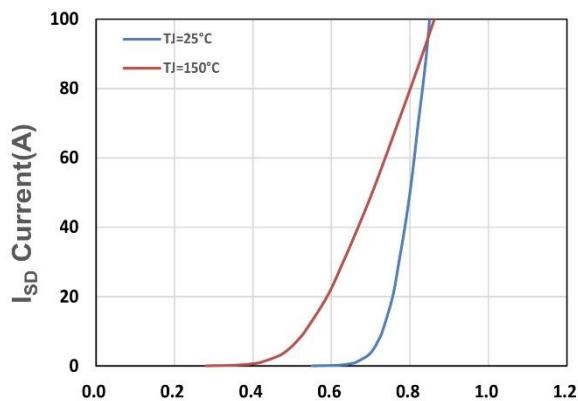
T_j , Junction Temperature(°C)

Figure 4. Gate Threshold Voltage



T_j , Junction Temperature(°C)

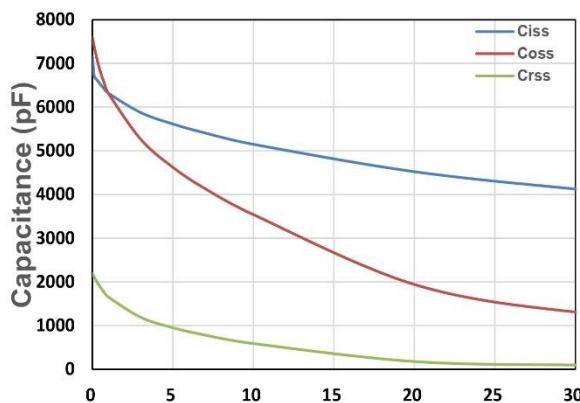
Figure 5. Drain-Source On Resistance



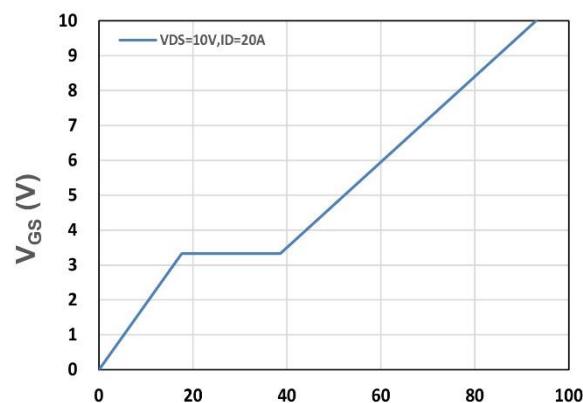
V_{SD} , Source-Drain Voltage(V)

Figure 6. Source-Drain Diode Forward

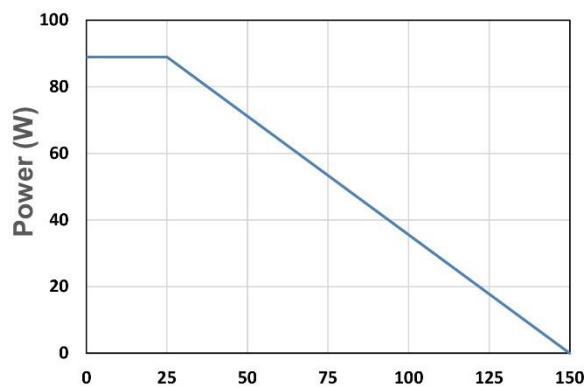
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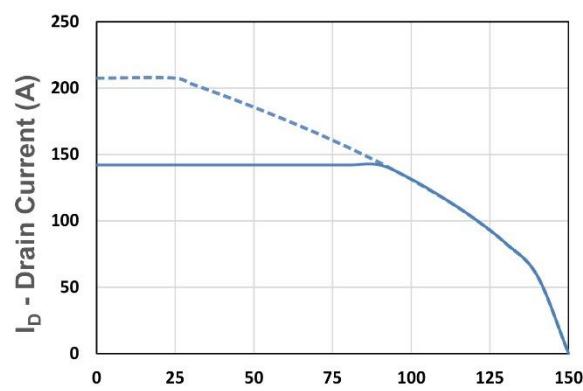
V_{DS} - Drain - Source Voltage (V)
Figure 7. Capacitance



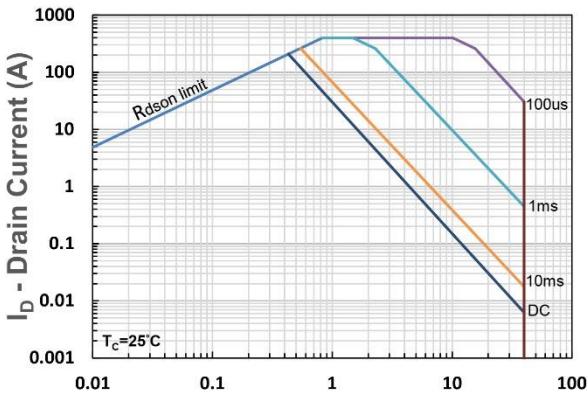
Q_g , Total Gate Charge (nC)
Figure 8. Gate Charge Characteristics



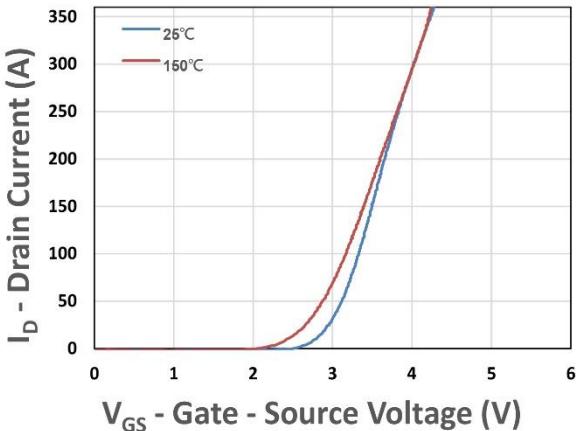
T_c - Case Temperature (°C)
Figure 9. Power Dissipation



I_D - Drain Current (A)
Figure 10. Drain Current



I_D - Drain Current (A)
 V_{DS} - Drain-Source Voltage (V)
Figure 11. Safe Operating Area



I_D - Drain Current (A)
 V_{GS} - Gate - Source Voltage (V)
Figure 12. Transfer Characteristics

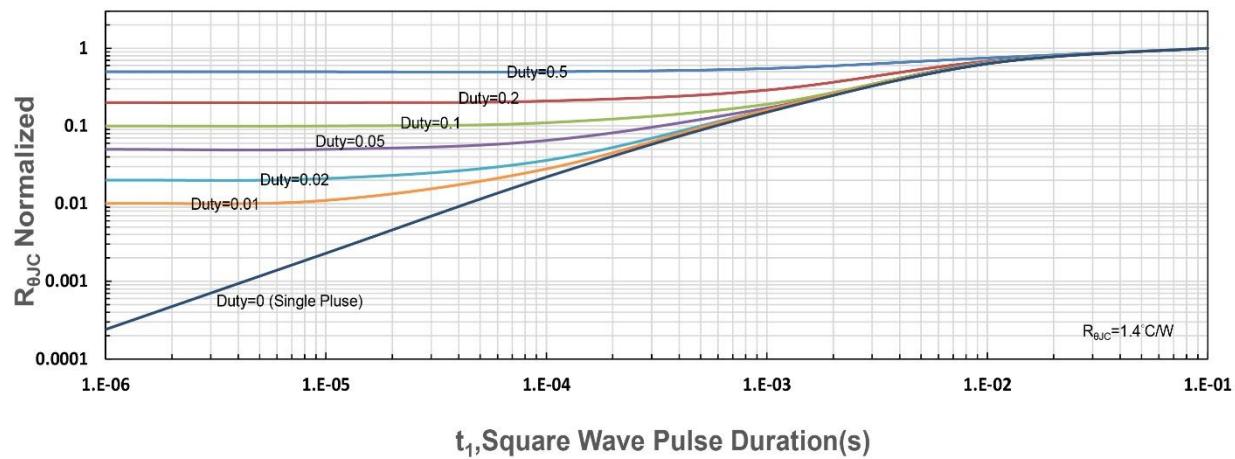


Figure 13. $R_{\theta JC}$ Transient Thermal Impedance